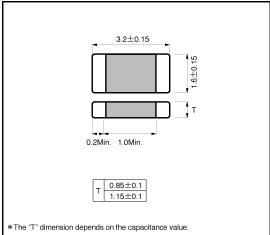
# Multi-layer ceramic chip capacitors MCH31 (3216 (1206) size, chip capacitor)

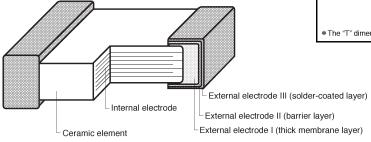
#### Features

- Small size (3.2 x 1.6 x 0.85 mm) makes it perfect for lightweight portable devices.
- Comes packed either in taping to enable automatic mounting.
- 3) Precise uniformity of shape and dimensions facilitates highly efficient automatic mounting.
- Solder-coated terminals offer superior solderability and resistance to soldering heat.

# ●External dimensions (Units: mm)



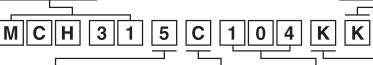
#### Structure



# Product Designation

Code	Product thickness	Packaging specifications	Reel	Basic ordening unit (pcs.)
K	0.85mm	Paper tape (width 8mm,pitch 4mm)	ø180mm (7in.)	4,000
L	0.85mm	Paper tape (width 8mm,pitch 4mm)	ø330mm (13in.)	16,000
Р	1.15mm	Plastic tape (width 8mm,pitch 4mm)	ø180mm (7in.)	3,000
œ	1.15mm	Plastic tape (width 8mm,pitch 4mm)	ø330mm (13in.)	12,000

Reel (\$\phi\$180,\$\phi\$330mm) : compatible EIAJ ETX-7001 **Packaging style** 



Rated voltage					
Code	Voltage				
2	25V				
3	16V				
5	50V				

Part No.

C	apacitance	e-temperature ch	Nominal	Capacitance tolerance		
Code	EIA code	Operating temperature range (°C)	Temp. coefficient or percent change	capacitance	Code	tolerance
Α	COG	-55 to +125	0±30ppm / ℃		J	±5%
С	X7R	-55 to +125	±15% (±10%)	3-digit designation according to IEC	к	±10%
F	Y5V	(-25 to +85) -30 to +85	+22%,-82%	according to IEC	z	+80%,-20%

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

# ■Capacitance range

For thermal compensation

Part num	MCH31	
	Temperature characteristics	A (C0G)
Capacitance (pF)	Rated voltage (V) Tolerance	50
270 300 330		
360 390 430		
470 510 560		
620 680 750		
820 910 1,000		
1,100 1,200 1,300		
1,500 1,600 1,800	J (±5%)	<b>******</b>
2,000 2,200 2,400		>>>>> >>>>>> >>>>>>
2,700 3,000 3,300		200000 2000000 20000000000000000000000
3,600 3,900 4,300		<b>******</b>
4,700 5,100 5,600		
6,200 6,800 7,500		
8,200 9,100 10,000		
11,000 12,000 13,000		

High dielectric constant

Part number		MCH31					
	Temperature characteristics	C (X7R)		F (Y5V)			
Capacitance (pF)	Rated voltage (V)	50	25	16	50	25	16
	Tolerance	ŀ	(±10%)		Z (-	<del>+</del> 80, <del>-</del> 20	)%)
220							
270							
330							
390							
470 560							
680 820							
1,000							
1,200							
1,500							
1,800							
2,200							
2,700							
3,300							
3,900							
4,700							
5,600							
6,800							
8,200 10,000 (0.01 μF)							
12,000 15,000							
18,000							
22,000							
27,000							
33,000							
39,000							
47,000							
56,000							
68,000							
82,000 100,000 (0.1 μF)							
		2000000					
120,000 150,000		******					
180,000			XXXXX				
220,000			******				
270,000			*******				
330,000			******				
390,000				******			
470,000				******	***************************************		
560,000							
680,000						*******	
1,000,000 (1 μF)						******	
1,200,000						(TOTOTOTOTOT)	
1,500,000 1,800,000						388888	
2,200,000							<b></b>
_,,							

Product thickness (mm)  $0.85\pm0.1$   $1.15\pm0.1$ 

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# Characteristics

Class 1 (For Thermal compensation)

Temperature characteristics		1 (222)	Test methods / conditions	
Item		A (COG)	(based on JIS C 5102)	
Operating temperature		-55°C∼+125°C		
Nominal capacitance (C)		Must be within the specified tolerance range.	Based on paragraph 7.8 and paragraph 9 Measured at room temperature and standard humidity Over 1000pF Measurement frequency: 1±0.1kHz Measurement voltage : 1±0.1Vrms	
Tan∂		0.1% or less		
Insulation resis	stance (IR)	10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller	Based on paragraph 7.6 is applied for 60±5s Measurement is made after rated voltage.	
Withstanding v	oltage	The insulation must not be damaged.	Based on paragraph 7.1 for 1 to 5s then measure Apply 300% of the rated voltage.	
Temperature c	haracteristics	Within 0±30ppm / °C	The temperature coefficients in table 12, paragraph 7.12 are calculated at 20°C and high temperature.	
Terminal adherence		No detachment or signs of detachment.	Based on paragraph 8. 11. 2 Apply 5N (0.51 kg·f) for 10±1s in the direction indicated by the arrow.	
	Appearance	There must be no mechanical damage.	Chip is mounted to a board in the manner	
Resistance to vibration	Rate of capacitance change	Must be within initial tolerance.	shown on the right, subjected to vibration (type A in paragraph 8.2), and	
	Tan δ	Must satisfy initial specified value.	measured 24±2 hrs. later. Board	
Solderability		At least 3 / 4 of the surface of the two terminals must be covered with new solder.	Based on paragraph 8.13 Soldering temperature : 235±5℃ Soldering time : 2±0.5s	
	Appearance	There must be no mechanical damage.		
	Rate of capacitance change	$\pm$ 2.5% or less, or $\pm$ 0.25 pF or less, whichever is larger.	Based on paragraph 8. 14	
Resistance to soldering	Tan δ	Must satisfy initial specified value.	Soldering temperature : 260±5°C Soldering time : 5±0.5s	
heat	Insulation resistance	10,000 MΩ or larger, or 500 ΩF or larger, whichever is smaller	Preheating : 150±10°C for 1 to 2 min.	
	Withstanding voltage	The insulation must not be damaged.		
	Appearance	There must be no mechanical damage.		
Temperature	Rate of capacitance change	$\pm$ 2.5% or less, or $\pm$ 0.25 pF or less, whichever is larger.	Based on paragraph 9.3, Number of cycles : 10	
cycling	Tan δ	Must satisfy initial specified value.	Capacitance measured after 24±2 hrs.	
	Insulation resistance	10,000 MΩ or larger, or 500 ΩF or larger, whichever is smaller		
	Appearance	There must be no mechanical damage.	Based on paragraph 9.9,	
Humidity load	Rate of capacitance change	$\pm 7.5\%$ or less, or $\pm 0.75$ pF or less, whichever is larger.	Test temperature : 40±2°C Relative humidity : 90% to 95%	
test	Tanδ	0.5% or less	Applied voltage : rated voltage	
	Insulation resistance	500 M $\Omega$ or larger, or 25 $\Omega$ F or larger, whichever is smaller	Test time : 500 to 524 hrs. Capacitance measured after 24±2 hrs.	
	Appearance	There must be no mechanical damage.	Based on paragraph 9.10,	
High-	Rate of capacitance change	$\pm 3.0\%$ or less, or $\pm 0.3$ pF or less, whichever is larger.	Test temperature : Max. operating temp.	
temperature load test	Tanδ	0.3% or less	Applied voltage : rated voltage x 200%  Test time : 1,000 to 1,048 hrs.	
	Insulation resistance	1,000 M $\Omega$ or larger, or 50 $\Omega$ F or larger, whichever is smaller	Capacitance measured after 24±2 hrs.	

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Class 2 (High dielectric constant)

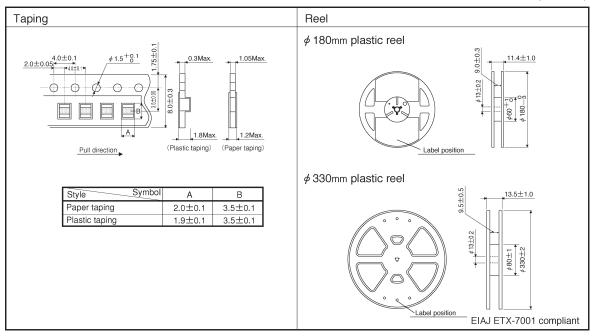
Class 2 (High die	lectric constant)				
Temperature characteristics		C (X7R)	F (Y5V)	Test methods / conditions (based on JIS C 5102)	
Operating temperature		-55°C∼+125°C	-30°C∼+85°C		
Nominal capacitance (C)		Must be within the spe	Based on paragraph 7.8 Measured at room temperature and standard humidity Measurement frequency : 1 ±0.1 kHz		
Tan δ		2.5% or less (when rated voltage is 16V: 3.5% or less)	5.0% or less (when rated voltage is 16V: 7.5% or less)	Measurement voltage : 1 ±0.2 Vrms.	
Insulation resistance (IR)		10,000 MΩ or larger, or 500 Ω	F or larger, whichever is smaller	Based on paragraph 7.6 is applied for 60±5s Measurement is made after rated voltage.	
Withstanding v	roltage	The insulation mus	st not be damaged.	Based on paragraph 7.1 for 1 to 5s then measure Apply 250% of the rated voltage.	
Temperature c	haracteristics	Within ±15%	±22, -82%	The temperature coefficients in paragraph 7.12, table 8, condition B, are based on measurements carried out at 20°C, with no voltage applied.	
Terminal adherence		No detachment or signs of detachment.		Based on paragraph 8. 11. 2 Apply 5N (0.51 kg·f) for 10±1s in the direction indicated by the arrow.  Pressure (5N) Test board Capacitor	
	Appearance	ppearance There must be no mechanical damage.		Chip is mounted to a board in the manner	
Resistance to vibration	Rate of capacitance change	Must be within	initial tolerance.	shown on the right, subjected to vibration (type A in paragraph 8.2), and	
	Tanδ	Must satisfy initia	measured 48±4 hrs. later.		
Solderability		At least 3 / 4 of the surface of the two terminals must be covered with new solder.		Based on paragraph 8.13 Soldering temperature: 235 ±5°C Soldering time : 2±0.5s	
	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	Within ±5.0%	Within ±20.0%	Based on paragraph 8. 14	
Resistance to soldering	Tanδ	Must satisfy initial specified value.		Soldering temperature : 260±5°C Soldering time : 5±0.5s	
heat	Insulation resistance	10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller		Preheating : 150±10°C for 1 to 2 min.	
	Withstanding voltage	The insulation mus	st not be damaged.		
	Appearance	There must be no n			
Temperature	Rate of capacitance change	Within ±7.5% Within ±20.0%		Based on paragraph 9.3, Number of cycles: 10	
cycling	Tanδ	Must satisfy initial specified value.		Capacitance measured after 48 ±4 hrs.	
	Insulation resistance	10,000 MΩ or larger, or 500 Ω	F or larger, whichever is smaller		
	Appearance	There must be no mechanical damage.		Based on paragraph 9.9,	
I le maiotte e le c	Rate of capacitance change	Within ±12.5%	Within ±30.0%	Test temperature: 40 ±2°C	
Humidity load test	Tan δ	5.0%or less	7.5% or less (when rated voltage is 16V: 10.0%)	Relative humidity: 90% to 95% Applied voltage : rated voltage Test time : 500 to 524 hrs.	
	Insulation resistance	500 M $\Omega$ or larger, or 25 $\Omega$ F or larger, whichever is smaller		Capacitance measured after 48 ±4 hrs.	
	Appearance	There must be no mechanical damage.		Pacad an paragraph 0.10	
High-	Rate of capacitance change	Within ±10.0%	Within ±30.0%	Based on paragraph 9.10, Test temperature: Max. operating temp.	
temperature load test	Tan δ	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Applied voltage : rated voltage x 200% Test time : 1,000 to 1,048 hrs. Capacitance measured after 48 ±4 hrs.	
	Insulation resistance	1,000M $\Omega$ or larger, or 500 $\Omega$ F	or larger, whichever is smaller	oapaolance measureu alter 48 ±4 fifs.	

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# Packaging specifications

(Units: mm)



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#### Electrical characteristics

# ■A (C0G) Characteristics

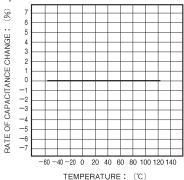


Fig.1 Capacitance - temperature characteristics

# ■C (X7R) Characteristics

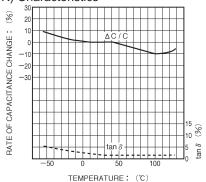


Fig.3 Capacitance - temperature characteristics

# ■F (Y5V) Characteristics

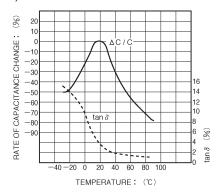


Fig.5 Capacitance - temperature characteristics

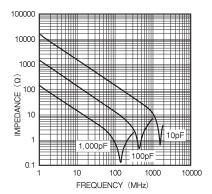


Fig.2 Impedance - frequency characteristics

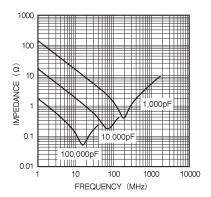


Fig.4 Impedance - frequency characteristics

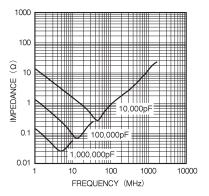
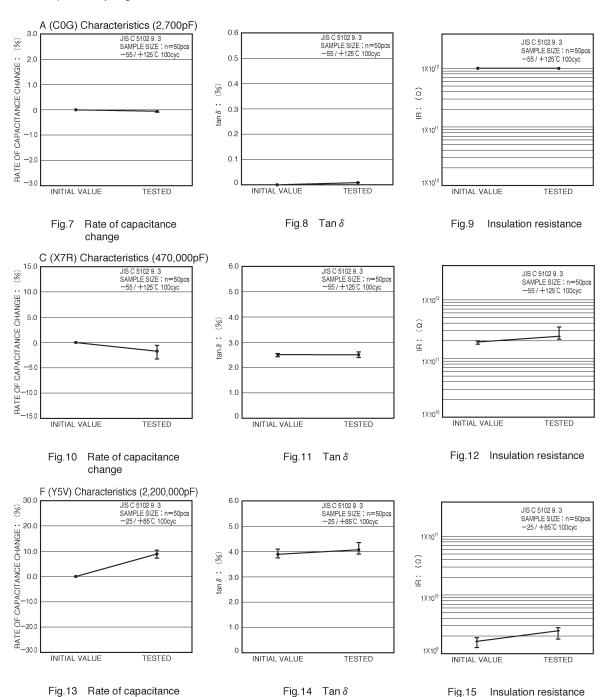


Fig.6 Impedance - frequency characteristics

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

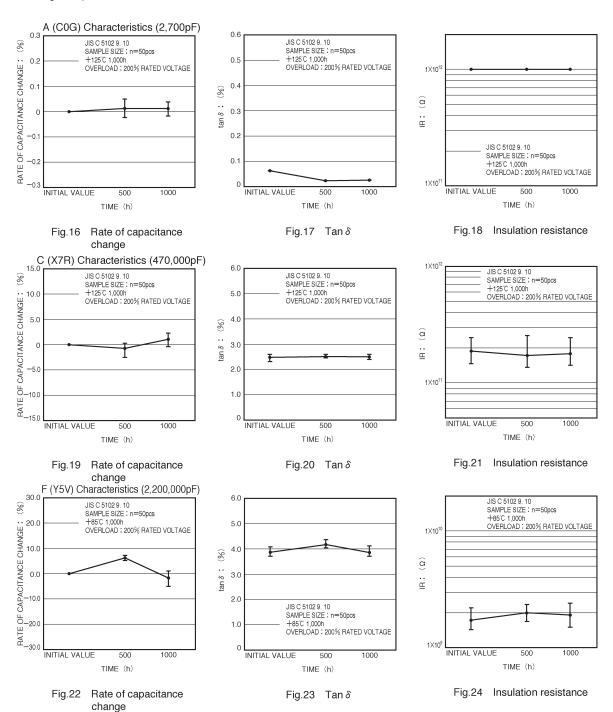
#### ■Temperature cycling test



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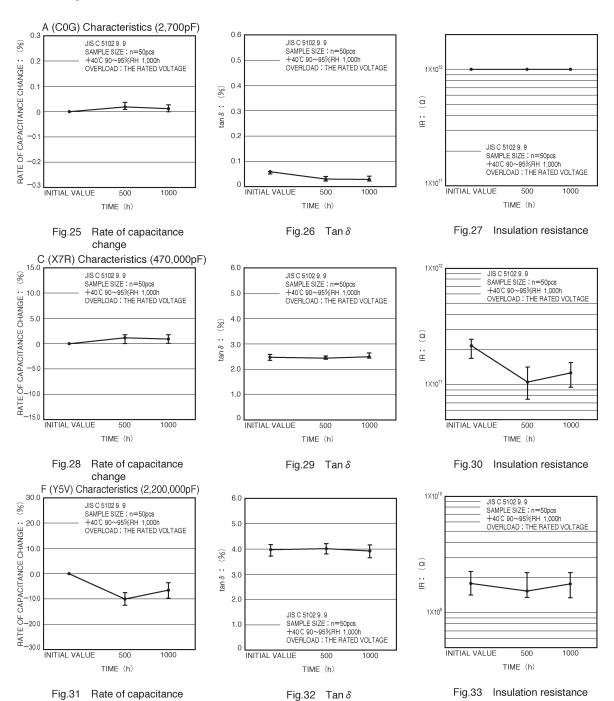
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#### ■High-temperature load test



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#### ■Humidity load test



<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

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